

GaN and SiC power semiconductor markets to surpass \$1bn in 2021

The gallium nitride & silicon carbide power semiconductor market is being energized by demand from electric vehicles, power supplies and PV inverters, says Omdia.

Energized by demand from hybrid & electric vehicles (HEVs), power supplies and photovoltaic (PV) inverters, the global market for silicon carbide (SiC) and gallium nitride (GaN) power semiconductors is forecast to grow to \$854m by the end of 2020 (up from just \$571m in 2018) then surpass \$1bn in 2021, according to Omdia's 'SiC & GaN Power Semiconductors Report — 2020'. Revenue is expected to increase at a double-digit annual rate for the next decade, surpassing \$5bn by 2029.

These long-term market projection totals are about \$1bn lower than those in last year's edition of the report because demand for almost all applications has slowed since 2018. Moreover, device average prices fell in 2019. Omdia adds a note a caution: the equipment forecasts used to create this year's forecast all date from 2019, and do not take account of the impact of the COVID-19 pandemic.

SiC Schottky diodes have been on the market for more than a decade, with SiC metal-oxide-semiconductor field-effect transistors (SiC MOSFETs) and junction-gate field-effect transistors (SiC JFETs) appearing in recent years. SiC power modules are also becoming increasingly available, including hybrid SiC modules, containing SiC diodes with silicon insulated-gate bipolar transistors (IGBTs), and full SiC modules containing SiC MOSFETs with or without SiC diodes.

SiC MOSFETs are proving popular among manufacturers, notes Omdia, with several companies already offering them. Several factors caused average pricing to fall in 2019, including the introduction of 650V, 700V and 900V SiC MOSFETs priced to compete with silicon superjunction MOSFETs, as well as increasing competition among suppliers.

"Declining prices will eventually spur faster adoption of SiC MOSFET technology," says Richard Eden, senior principal analyst for power semiconductors. "In contrast, GaN power transistors and GaN system ICs have only appeared on the market quite recently," he adds. "GaN is a wide-bandgap material offering similar performance benefits as SiC, but with a higher cost-reduction potential. These price and performance

advantages are possible because GaN power devices can be grown on either silicon or sapphire substrates, which are less expensive than SiC. Although GaN transistors are now available, sales of GaN system integrated circuits, from companies such as Power Integrations, Texas Instruments and Navitas Semiconductor, are forecast to rise at a faster rate."

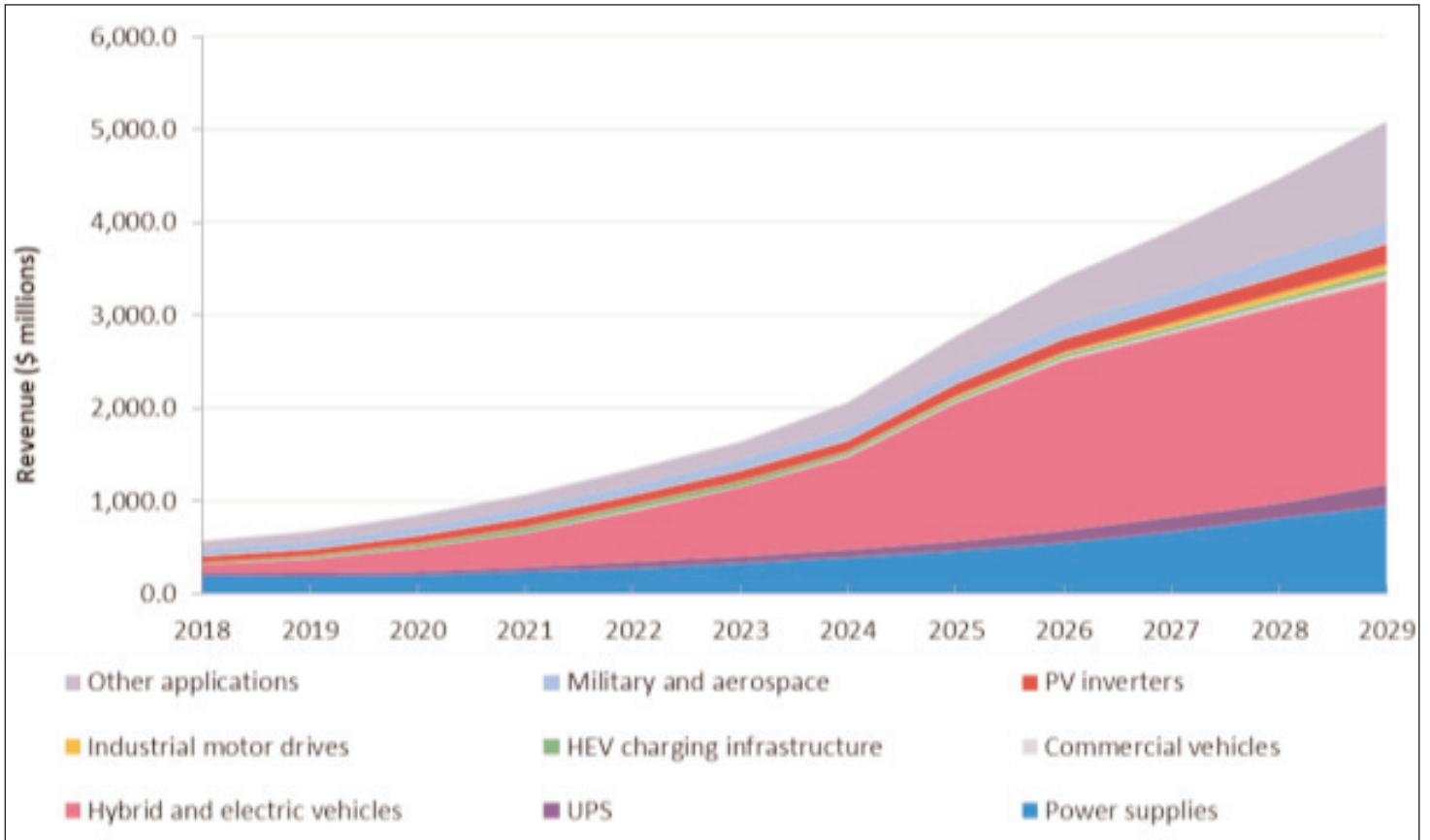
SiC and GaN power semiconductor market trends

By the end of 2020, SiC MOSFETs are forecasted to generate revenue of about \$320m, matching that of Schottky diodes. From 2021 onwards, SiC MOSFETs will grow at a slightly faster rate to become the best-selling discrete SiC power device, it is expected. Meanwhile, SiC JFETs are each forecasted to generate much smaller revenues than those of SiC MOSFETs, despite achieving good reliability, price and performance. "End-users strongly prefer normally-off SiC MOSFETs, so SiC JFETs appear likely to remain specialized, niche products," Eden says. "However, sales of SiC JFETs are forecast to rise at an impressive rate, despite having very few active suppliers."

It is estimated that, in 2019, hybrid SiC power modules (combining Si IGBTs and SiC diodes) generated \$72m in sales and full SiC power modules generated \$50m. Full SiC power module revenue is forecasted to exceed \$850m by 2029, as they will be preferred for use in HEV powertrain inverters. In contrast, hybrid SiC power modules will be used mainly in PV inverters, uninterruptible power supply (UPS) systems and other industrial applications, delivering a much slower growth rate.

What has changed since 2019?

There are now trillions of hours of device field experience available for both SiC and GaN power devices. Suppliers, even new market entrants, are demonstrating this by obtaining JEDEC and AEC-Q101 approvals. There do not appear to be any unexpected reliability problems with SiC and GaN devices; in fact, they usually appear better than silicon, notes Omdia.



Market forecast for GaN and SiC power semiconductors (millions of US dollars).

SiC MOSFETs and SiC JFETs are available at lower operating voltages, such as 650V, 800V and 900V, allowing SiC to compete with Si Superjunction MOSFETs on both performance and price.

End-products with GaN transistors and GaN system ICs inside are in mass production, particularly USB type-C power adaptors and chargers for fast charging of mobile

phones and notebook PCs. Also, many GaN devices are being made by foundry service providers, offering in-house GaN epitaxial crystal growth on standard silicon wafers, and potentially unlimited production capacity expansion as volumes ramp, concludes the report. ■

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